ASSOCIATION CONNECTING LECTRONICS INDUSTRIES	PC. Bannockl	ourn. Illinois. A	Ill rights reserved untions.	under both This level	documer parts, th	nt is a declaration ne declaration er	on of the su	bstances all lower	within the manufactur r level materials for w	er listed	item. Note: manufactur	if the item is an a rer has engineering	ssembly with lower responsibility.	
52.21.1 IPC Web Site for Information on IPC-1752 Standard For				Form Type * Distribute					als and Mfg Information					
Supplier Information														
Company name*	Company unique ID			U	1 5					Response Date*				
semi				Phone - Contact*				2023-06-08 Email - Contact*						
Product-Env-Stewards Prod			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	n Number	Number Mfr Item Name			Effective Date Version Manufacturing S		Anufacturing Site		Weight*	UOM	Unit Type		
	LE24641	LE2464RDXATDG 64K bit I2C Fast-Plu WLCSP		Plus EEPROM, Vcc	=1.8V,	2023-06-08	РНМ			1.0	mg	Each		
Manufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	ninal Plating / Grid Array Material Terminal Base Alloy J-S			J-STD-020 MSL Rati	Rating Peak Process Body Temperature Max Time at Pea				Temperature Number of Reflow Cycles					
SnAgCu CU Alloy 1		1		260		С	30	seco	nds 3					
Comments														
evel 1 - maximum time at peak temperat	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.77	mg	Supplier	Silicon (Si)	7440-21-3		0.77	mg	
Electrode	0.05	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0498	mg	
Protection coat	0.05	mg	Supplier	Epoxy resins	129915-35-1		0.05	mg	
Solder Ball	0.13	mg	Supplier	Silver (Ag)	7440-22-4		0.0039	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1254	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0006	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3